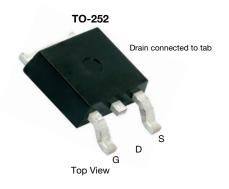
SQD40131EL

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Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET

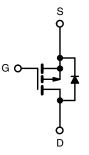


PRODUCT SUMMARY				
V _{DS} (V)	-40			
$R_{DS(on)}$ (Ω) at V_{GS} = -10 V	0.0115			
$R_{DS(on)}\left(\Omega\right)$ at V_{GS} = -4.5 V	0.0150			
I _D (A)	-50			
Configuration	Single			
Package	TO-252			

FEATURES

- TrenchFET[®] power MOSFET
- · Package with low thermal resistance
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>





P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unless	otherwise noted	ł)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-40	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C ª	- I _D	-50		
	T _C = 125 °C		-31		
Continuous source current (diode conduction) ^a		IS	-50	А	
Pulsed drain current ^b		I _{DM}	-180		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-27		
Single pulse avalanche energy		E _{AS}	36.4	mJ	
Maximum power dissipation ^b	T _C = 25 °C	D	62	W	
	T _C = 125 °C	P _D	20	vv	
Operating junction and storage temperature	range	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^c	R _{thJA}	50	°C/W
Junction-to-case (drain)		R _{thJC}	2.4	C/W

Notes

a. Package limited

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. When mounted on 1" square PCB (FR4 material)

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		<u>.</u>			•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		-40	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1.5	-2	-2.5	
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = -40 V	-	-	-1	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 125 °C	-	-	-50	μA
		$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 175 °C	-	-	-250	1
On-state drain current ^a	I _{D(on)}	$V_{GS} = -10 V$	$V_{DS} \ge 5 V$	-30	-	-	Α
		$V_{GS} = -10 V$	I _D = -30 A	-	0.0095	0.0115	
Duraina a successive and a state marciate and a	P	V _{GS} = -10 V	I _D = -30 A, T _J = 125 °C	-	-	0.0171	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -10 \text{ V}$	I _D = -30 A, T _J = 175 °C	-	-	0.0203	Ω
		$V_{GS} = -4.5 V$	I _D = -25 A	-	0.0121	0.0150	1
Forward transconductance ^b	9 _{fs}	V _{DS} =	-15 V, I _D = -30 A	-	71	-	S
Dynamic ^b		<u>.</u>					
Input capacitance	C _{iss}		V _{DS} = -25 V, f = 1 MHz	-	4872	6600	
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	344	500	pF
Reverse transfer capacitance	C _{rss}			-	316	450	1
Total gate charge ^c	Qg			-	76	115	
Gate-source charge ^c	Q_gs	V _{GS} = -10 V	$V_{DS} = -20 \text{ V}, \text{ I}_{D} = -30 \text{ A}$	-	11.5	-	nC
Gate-drain charge ^c	Q _{gd}			-	13.5	-	
Gate resistance	R _g		f = 1 MHz		4	6	Ω
Turn-on delay time ^c	t _{d(on)}	V _{DD} = -20 V, R _L = 0.7 Ω		-	13	20	
Rise time ^c	t _r			-	7	15	1
Turn-off delay time ^c	t _{d(off)}	I _D ≅ -30 A,	$I_D \cong -30$ Å, $V_{GEN} = -10$ V, $R_g = 1 \Omega$		66	100	ns
Fall time ^c	t _f	1		-	28	45	
Source-Drain Diode Ratings and Charac	teristics ^b						
Pulsed current ^a	I _{SM}			-	-	-180	Α
Forward voltage	V _{SD}	I _F = -30 A, V _{GS} = 0 V		-	-0.9	-1.5	V
Body diode reverse recovery time	t _{rr}			-	43	90	ns
Body diode reverse recovery charge	Q _{rr}	1		-	45	100	nC
Reverse recovery fall time	t _a	I _F = -30	I _F = -30 A, di/dt = 100 A/μs		26	-	İ
Reverse recovery rise time	t _b			-	17	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-2.8	-	Α

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

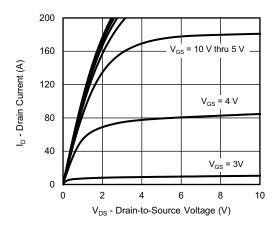
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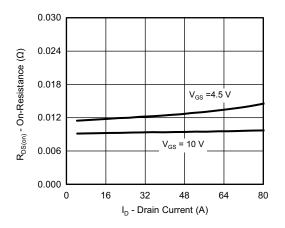
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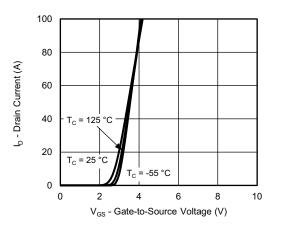
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



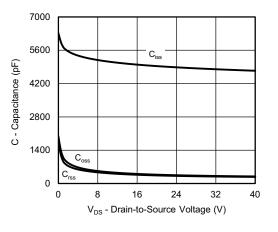
Output Characteristics



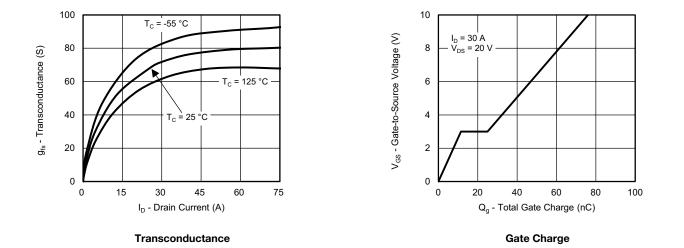
On-Resistance vs. Drain Current



Transfer Characteristics



Capacitance



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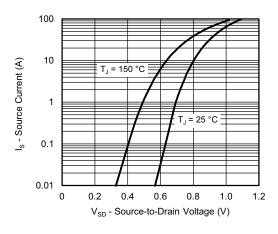
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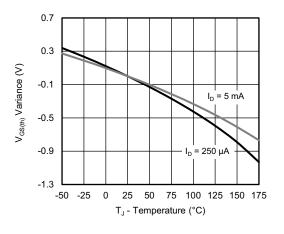


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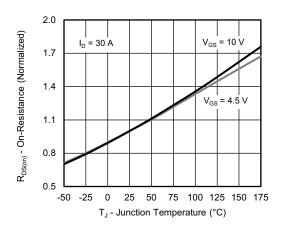
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



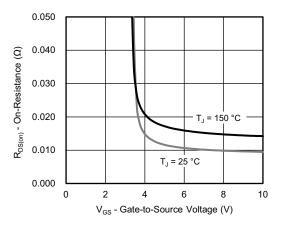
Source Drain Diode Forward Voltage



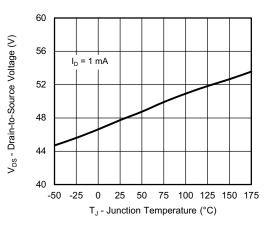
Threshold Voltage



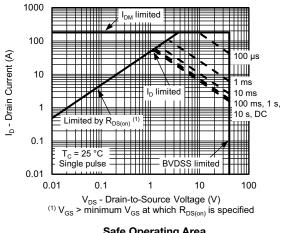
On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



Safe Operating Area

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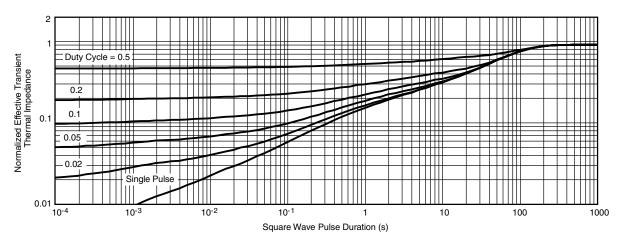
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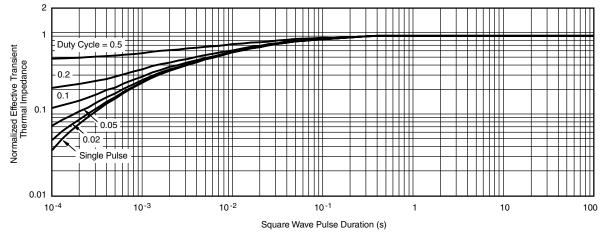


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

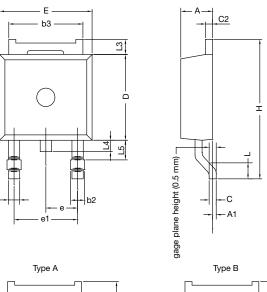
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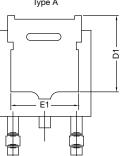
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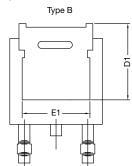


TO-252AA Case Outline





b



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	2.28 BSC		BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	

Notes

• Dimension L3 is for reference only

• Dimension D1 and E1 on type A and B is the same

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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